



Product Change Notification

Change Notification #: 114936 - 00
Change Title: Intel® Server System R1208WT2GSR,
Intel® Server System R1304WTTGSR,
PCN 114936-00,
Product Design, Product Material,
System RoHS compliance exemption free
conversion and Updated
BIOS/ME/BMC/FRUSDR Firmware
Date of Publication: September 29, 2016

Key Characteristics of the Change:

Product Design, Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	Oct 15, 2016
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server Systems R1208WT2GSR and R1304WTTGSR:

1. Replacement of components containing substances listed under EU RoHS exemption 6(c), 7(c) and 15 with exemption free versions. All new components are identical in form factor and function to the replaced ones.

Components containing substances listed under EU RoHS exemption 7(a) are not affected with the exception of one IC.

2. Update of the System Firmware installed at the Factory:
 - a. Update the BIOS from revision R01.01.0014 to revision R01.01.0016.
 - b. Update the Manageability Engine (ME) firmware from revision 03.01.03.005 to revision 03.01.03.021.
 - c. Update the Integrated Baseboard Management Controller (BMC) firmware from revision 1.13.8932 to revision 01.43.9685.
 - d. Update the FRUSDR from revision 1.11 to revision 1.13
 - e. PSOC update from 1.12 to 1.19 on HSBPs

The system software update package, including the release notes for each, is available for download from <http://www.intel.com/support>. Please refer to the software release notes for a list of changes.

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
R1304WTTGSR	943891	J11482-003	G92187-367	J11482-004	G92187-371
R1208WT2GSR	943894	J11465-002	H21573-366	J11465-003	H21573-371

PCN Revision History:

Date of Revision:

September 29, 2016

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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